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ON Semiconductor®



PCFFS40120AF

Silicon Carbide Schottky Diode 1200 V, 40 A

Features

- Max Junction Temperature 175 °C
- · Avalanche Rated 420 mJ
- · High Surge Current Capacity
- · Positive Temperature Coefficient
- · Ease of Paralleling
- · No Reverse Recovery / No Forward Recovery

Applications

- · General Purpose
- · SMPS, Solar Inverter, UPS
- · Power Switching Circuits

Description

Silicon Carbide (SiC) Schottky Diodes use a completely new technology that provides superior switching performance and higher reliability compared to Silicon. No reverse recovery current, temperature dependent switching characteristics, and excellent thermal performance sets Silicon Carbide as the next generation of power semiconductor. System benefits include highest efficiency, faster operation frequency, increased power density, reduced EMI, and reduced system size and cost.

Die Information

Wafer Diameter 6 inch

• Die Size 4,200 x 4,200 μm (include Scribe Lane)

Metallization

· Top Ti / TiN / AlCu 4μm · Back Ti / NiV /Ag

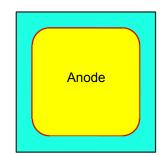
• Die Thickness Typ. $200\mu m$

· Bonding Pad Size

• Anode $3,620 \times 3,620 \ \mu m$

Recommended Wire Bond (Note 1)

· Anode 20mil ×3



Electrical Characteristics on Wafer (Note 2) T_C = 25°C unless otherwise noted.

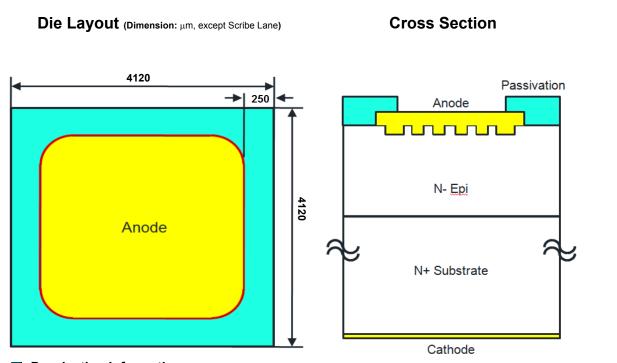
| Symbol | Parameter | Test Conditions | Min. | Тур. | Max. | Unit |
|----------------|--------------------------|--|------|------|------|------|
| V_R | Reverse Blocking Voltage | $I_R = 200 \mu A, T_C = 25 {}^{\circ}C$ | 1200 | - | - | V |
| V_{F} | Forward Voltage | $I_F = 40 \text{ A}, T_C = 25 ^{\circ}\text{C}$ | 1.20 | - | 1.75 | V |
| I _R | Reverse Current | V _R = 1200 V, T _C = 25 °C | - | - | 200 | μΑ |

Notes:

- 1. Based on TO-247 package of ON Semiconductor
- 2. Tested 100% on wafer

For Additional Product Information and Electrical Characteristics on Package

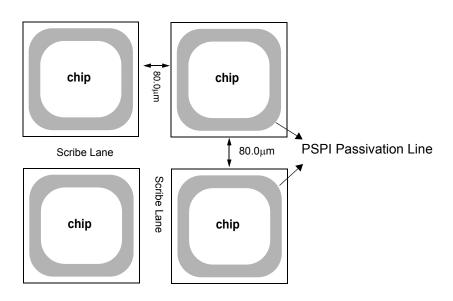
Refer to FFSH40120A product datasheet.



Passivation Information

- Passivation Material: Polymide (PSPI)
- Passivation Type: Local Passivation
- Passivation Thickness: 90KA

The Configuration of chips (Based on 6 inch wafer)





FFSH40120A

Silicon Carbide Schottky Diode 1200 V, 40 A

Features

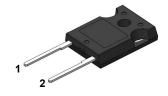
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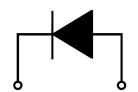
- · General Purpose
- · SMPS, Solar Inverter, UPS
- · Power Switching Circuits

Description

Silicon Carbide (SiC) Schottky Diodes use a completely new technology that provides superior switching performance and higher reliability compared to Silicon. No reverse recovery current, temperature independent switching characteristics, and excellent thermal performance sets Silicon Carbide as the next generation of power semiconductor. System benefits include highest efficiency, faster operating frequency, increased power density, reduced EMI, and reduced system size & cost.



TO-247-2L



1. Cathode

2. Anode

Absolute Maximum Ratings $T_C = 25 \, ^{\circ}C$ unless otherwise noted.

| Symbol | Paramete | FFSH40120A | Unit | |
|-----------------------------------|--|--|-------------|-----|
| V_{RRM} | Peak Repetitive Reverse Voltage | | 1200 | V |
| E _{AS} | Single Pulse Avalanche Energy (Note 1) | | 420 | mJ |
| 1 | Continuous Rectified Forward Current @ Tc < 155 °C | | 40 | Α |
| IF | Continuous Rectified Forward Current @ Tc < 135 °C | | 61 | Α |
| I _{F, Max} | Non-Repetitive Peak Forward Surge Current | T _C = 25 °C, 10 μs | 1650 | Α |
| | | T _C = 150 °C, 10 μs | 1550 | Α |
| I _{F,SM} | Non-Repetitive Forward Surge Current | Half-Sine Pulse, t _p = 8.3 ms | 270 | Α |
| I _{F,RM} | Repetitive Forward Surge Current | Half-Sine Pulse, t _p = 8.3 ms | 120 | Α |
| Ptot | Pawer Dissination | T _C = 25 °C | 682 | W |
| | Power Dissipation | T _C = 150 °C | 114 | W |
| T _J , T _{STG} | Operating and Storage Temperature Range | | -55 to +175 | °C |
| | TO247 Mounting Torque, M3 Screw | | 60 | Ncm |

Thermal Characteristic

| Symbol | Parameter | Rating | Unit |
|-----------------|---|--------|------|
| $R_{\theta JC}$ | Thermal Resistance, Junction to Case, Max | 0.22 | °C/W |

Package Marking and Ordering Information

| Part Number | Top Mark | Package | Packing Method | Reel Size | Tape Width | Quantity |
|-------------|------------|-----------|----------------|-----------|------------|----------|
| FFSH40120A | FFSH40120A | TO-247-2L | Tube | N/A | N/A | 30 units |

Electrical Characteristics $T_C = 25$ °C unless otherwise noted.

| Parameter | Test Conditions | Min. | Тур. | Max. | Unit |
|-------------------------|---|------|---|--|--|
| Forward Voltage | I _F = 40 A, T _C = 25 °C | - | 1.45 | 1.75 | V |
| | I _F = 40 A, T _C = 125 °C | - | 1.7 | 2.0 | |
| | I _F = 40 A, T _C = 175 °C | - | 2.0 | 2.4 | |
| | V _R = 1200 V, T _C = 25 °C | - | - | 200 | |
| Reverse Current | $V_R = 1200 \text{ V}, T_C = 125 ^{\circ}\text{C}$ | - | - | 300 | μА |
| | $V_R = 1200 \text{ V}, T_C = 175 {}^{\circ}\text{C}$ | - | - | 400 | |
| Total Capacitive Charge | V = 800 V | - | 220 | - | nC |
| | V _R = 1 V, f = 100 kHz | - | 2250 | - | |
| Total Capacitance | $V_R = 400 \text{ V}, f = 100 \text{ kHz}$ | - | 204 | - | pF |
| | $V_R = 800 \text{ V}, f = 100 \text{ kHz}$ | - | 169 | - | |
| | Forward Voltage Reverse Current Total Capacitive Charge | | $\begin{array}{c} I_F = 40 \text{ A, } T_C = 25 ^{\circ}\text{C} & - \\ I_F = 40 \text{ A, } T_C = 125 ^{\circ}\text{C} & - \\ I_F = 40 \text{ A, } T_C = 125 ^{\circ}\text{C} & - \\ I_F = 40 \text{ A, } T_C = 175 ^{\circ}\text{C} & - \\ V_R = 1200 \text{ V, } T_C = 25 ^{\circ}\text{C} & - \\ V_R = 1200 \text{ V, } T_C = 125 ^{\circ}\text{C} & - \\ V_R = 1200 \text{ V, } T_C = 175 ^{\circ}\text{C} & - \\ V_R = 1200 \text{ V, } T_C = 175 ^{\circ}\text{C} & - \\ V_R = 100 \text{ V, } T_C = 175 ^{\circ}\text{C} & - \\ V_R = 100 \text{ V, } T_C = 175 ^{\circ}\text{C} & - \\ V_R = 100 \text{ V, } T_C = 175 ^{\circ}\text{C} & - \\ V_R = 100 \text{ V, } T_C = 175 ^{\circ}\text{C} & - \\ V_R = 100 \text{ V, } T_C = 175 ^{\circ}\text{C} & - \\ V_R = 100 \text{ V, } T_C = 175 ^{\circ}\text{C} & - \\ V_R = 100 \text{ V, } T_C = 100 \text{ KHz} & - \\ \end{array}$ | $ \begin{array}{c ccccccccccccccccccccccccccccccccccc$ | $ \begin{array}{c ccccccccccccccccccccccccccccccccccc$ |

Notes:

Typical Characteristics $T_J = 25$ °C unless otherwise noted.

Figure 1. Forward Characteristics

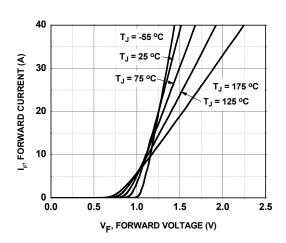


Figure 3. Current Derating

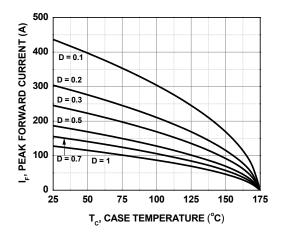


Figure 2. Reverse Characteristics

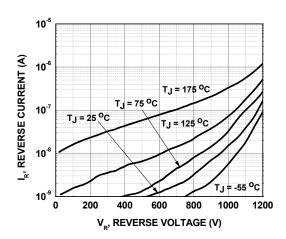
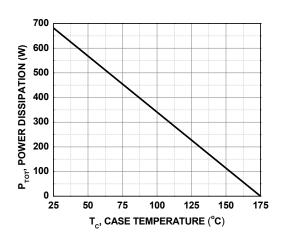


Figure 4. Power Derating



^{1:} E_{AS} of 420 mJ is based on starting T_J = 25 °C, L = 0.5 mH, I_{AS} = 41 A, V = 50 V.

Typical Characteristics T_J = 25 °C unless otherwise noted.

Figure 5. Capacitive Charge vs. Reverse Voltage

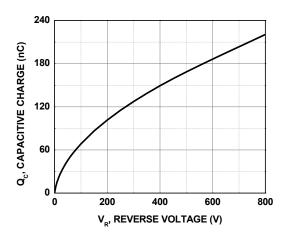


Figure 6. Capacitive vs. Reverse Voltage

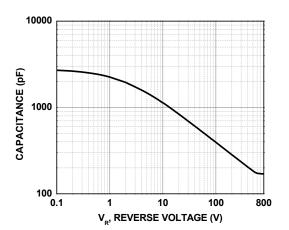


Figure 7. Capacitance Stored Energy

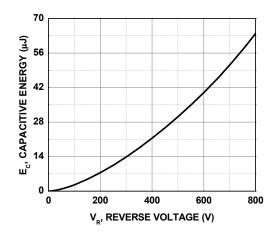
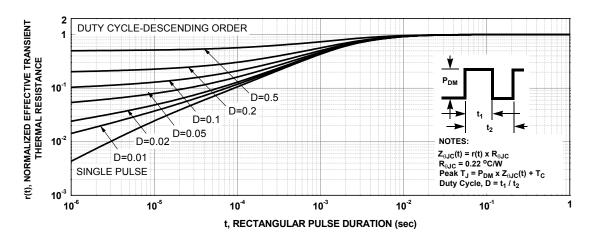


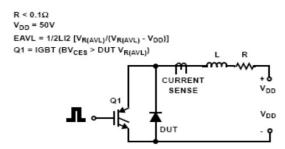
Figure 8. Junction-to-Case Transient Thermal Response Curve

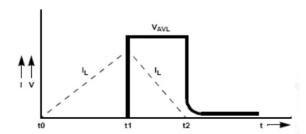


Test Circuit and Waveforms

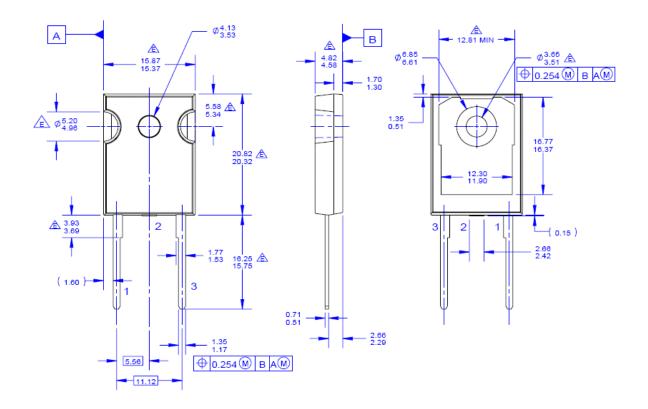
Figure 9. Unclamped Inductive Switching Test Circuit & Waveform

L = 0.5mH





Mechanical Dimensions



NOTES: UNLESS OTHERWISE SPECIFIED.

- A. PACKAGE REFERENCE: JEDEC TO-247, ISSUE E, VARIATION AB, DATED JUNE, 2004.
- B. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS.
- C. ALL DIMENSIONS ARE IN MILLIMETERS.
- D. DRAWING CONFORMS TO ASME Y14.5 2009.
- E DOES NOT COMPLY JEDEC STANDARD VALUE.
- F. DRAWING FILENAME: MKT-TO247B02 REV04.
- G. FAIRCHILD SEMICONDUCTOR.

Figure 10. TO-247, Molded, 2LD, Jedec Option AB

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